IN THE SPECIFICATION

Lease amend the specification by inserting headings as indicated.

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Field of the invention

The present invention is related to production of solar cells, and more precisely to a method and a system for establishing correspondence between wafers and solar cells produced from said wafers, to provide solar cell traceability.

Background of the invention

A solar cell panel comprises a matrix of solar cells, which convert sun light into electricity. Each solar cell is produced by treating a silicon wafer. Silicon wafers are cut out of a large silicon body called ingot.

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Summary of the invention

The present invention has as an aim to provide a method and a system which do not modify the wafer's surface, and at the same time do not require adapting the tracking system to different pieces of equipment.

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Brief description of the drawings

The invention will now be described by means of an example illustrated in the drawings, where:

Detailed description of the invention

Figure 1 is a block diagram illustrating wafer manufacture. The point of departure (step 101) is a silicon ingot 1. This ingot is first sectioned into smaller ingots 2 (step 102), and these are sawed (step 103) by means of wire saws into wafers 3 (step 104). As one can see, the grain structure of the wafer is not modified during this production process.